Certificate TW19/10223

The management system of

King Yuan Electronics Co., Ltd.

No. 118, Chung-Hua Rd., Chu-Nan, Miao-Li Hsien, 350, Taiwan, R.O.C.

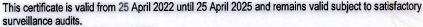
has been assessed and certified as meeting the requirements of

ISO 13485:2016 EN ISO 13485:2016

For the following activities

1. Manufacturing of Semiconductor through Grinding, Dicing, Probing, Testing and Backend Processing for Active Medical Device

2. Manufacturing of IC Package and Modules Assembly for Active Medical Device



Issue 2. Certified since 25 April 2019.

Certified activities performed by additional sites listed on subsequent pages.

Authorised by



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Certificate TW19/10223, continued

King Yuan Electronics Co., Ltd.

ISO 13485:2016 EN ISO 13485:2016



Sites

King Yuan Electronics Co., Ltd. No. 118, Chung-Hua Rd., Chu-Nan, Miao-Li Hsien, 350, Taiwan, R.O.C.

1. Manufacturing of Semiconductor through Grinding, Dicing, Probing, Testing and Backend Processing for Active Medical Device

2. Manufacturing of IC Package and Modules Assembly for Active Medical Device

King Yuan Electronics Co., Ltd.

No. 81, Sec. 2, Gongdaowu Rd., Hsin-Chu City, 300, Taiwan, R.O.C.

1. Manufacturing of Semiconductor through Grinding, Dicing, Probing, Testing and Backend Processing for Active Medical Device

2. Manufacturing of IC Package and Modules Assembly for Active Medical Device

King Yuan Electronics Co., Ltd.

No. 8, Tongke N. Rd., Tongluo, Miao-Li Hsien, 366, Taiwan, R.O.C.

1. Manufacturing of Semiconductor through Grinding, Dicing, Probing, Testing and Backend Processing for Active Medical Device

2. Manufacturing of IC Package and Modules Assembly for Active Medical Device

King Yuan Electronics Co., Ltd.

No. 8, Ln. 228, Chung-Hua Rd., Chu-Nan, Miao-Li Hsien, 350, Taiwan, R.O.C.

1. Manufacturing of Semiconductor through Grinding, Dicing, Probing, Testing and Backend Processing for Active Medical Device

2. Manufacturing of IC Package and Modules Assembly for Active Medical Device



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